

ExaMAX®





COLUMN

PITCH

-2.0

= (2.0 mm)

.0787"

(2.00 mm) .0787"

ExaMAX® BACKPLANE SYSTEM

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?EBTF-RA

see www.samtec.com?EBTF
Insulator Material:
Liquid Crystal Polymer
Contact Material:
Copper Alloy
Plating:
Sn or Au over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +105 °C
Current Rating:
4.2 A per pin
(1 pin powered)
Contact Wipe:
2.4 mm
RoHS Compliant:

RECOGNITIONS

RoHS Compliant:

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

Staging

TOOLING

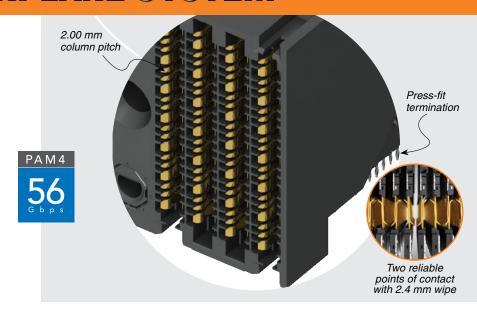
 For press-fit extraction and insertion tool options, visit www.samtec.com/tooling

Some lengths, styles and options are non-standard, non-returnable.

ExaMAX® is a registered trademark of AFCI.

Mates with:

EBTM, EBDM



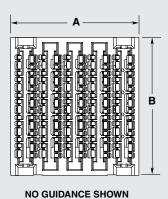
NO. OF PAIRS PER COLUMN **EBTF**

_4 = 4 Pairs

-6 = 6 Pairs

-06 -08**-10**

В	
(22.50) .886	
(29.70) 1.169	



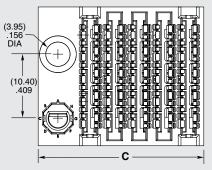
NO. OF PAIRS PER COLUMN

-6

COLUMNS

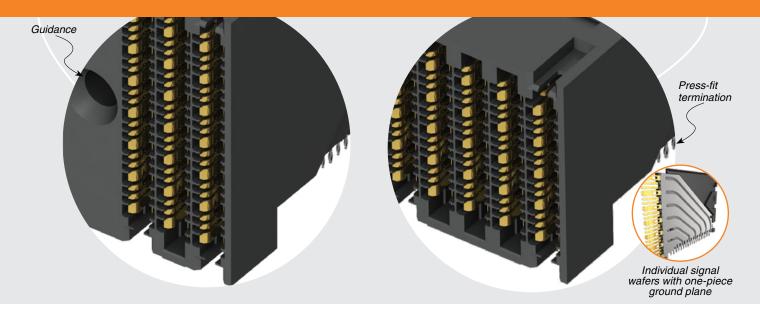
-12 (-6 only)

COLUMNS	Α	С
-06	(12.90) .508	(18.85) .742
-08	(16.90) .665	(22.85) .900
-10	(20.90) .823	(26.85) 1.057
-12	(24 90) 980	(30.85) 1.215



WITH GUIDANCE SHOWN

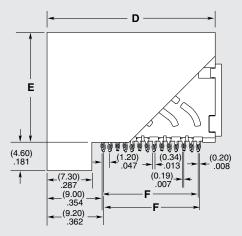






—**S** = 30 μ" (0.76 μm) Gold on contact area, Matte Tin on tail

GUIDANCE	KEYING							
	-A	-B	Ļ	-D	-E	–F	-G	-H
–R /–L	c B A H G	$G = \begin{bmatrix} A \\ C \end{bmatrix}_{E}^{H} G$						$G = \begin{bmatrix} A \\ C \end{bmatrix}_{E} G$



EBTF-4-10-2.0-S-RA-1-L-A SHOWN

(Leave Blank for no Guidance)

= Left Guidance

-R = Right Guidance

KEYING

(Only available with -L or -R guidance) (Leave Blank for no keying)

-A thru -H = Position of flat on Key (See table for Key)



NO. OF PAIRS PER COLUMN	D	E	F
-4	(28.40)	(17.90)	(15.60)
	1.118	.705	.614
-6	(35.60)	(25.10)	(22.80)
	1.402	.988	.898

Due to technical progress, all designs, specifications and components are subject to change without notice.

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